

HR 4549

Building Chips in America Act of 2023

Congress: 118 (2023–2025, Ended)

Chamber: House

Policy Area: Environmental Protection

Introduced: Jul 11, 2023

Current Status: Referred to the Subcommittee on Innovation, Data, and Commerce.

Latest Action: Referred to the Subcommittee on Innovation, Data, and Commerce. (Jul 14, 2023)

Official Text: <https://www.congress.gov/bill/118th-congress/house-bill/4549>

Sponsor

Name: Rep. Kiggans, Jennifer A [R-VA-2]

Party: Republican • **State:** VA • **Chamber:** House

Cosponsors (12 total)

Cosponsor	Party / State	Role	Date Joined
Rep. Allred, Colin Z. [D-TX-32]	D · TX		Jul 11, 2023
Rep. McCaul, Michael T. [R-TX-10]	R · TX		Jul 11, 2023
Rep. Peters, Scott H. [D-CA-50]	D · CA		Jul 11, 2023
Rep. Williams, Brandon [R-NY-22]	R · NY		Jul 11, 2023
Rep. Slotkin, Elissa [D-MI-7]	D · MI		Jul 20, 2023
Rep. Sykes, Emilia Strong [D-OH-13]	D · OH		Jul 20, 2023
Rep. Gallego, Ruben [D-AZ-3]	D · AZ		Aug 4, 2023
Rep. Carter, Earl L. "Buddy" [R-GA-1]	R · GA		Oct 11, 2023
Rep. Lawler, Michael [R-NY-17]	R · NY		Oct 13, 2023
Rep. Stanton, Greg [D-AZ-4]	D · AZ		May 7, 2024
Rep. Garcia, Mike [R-CA-27]	R · CA		May 31, 2024
Rescom. González-Colón, Jenniffer [R-PR-At Large]	R · PR		Sep 23, 2024

Committee Activity

Committee	Chamber	Activity	Date
Armed Services Committee	House	Referred To	Jul 11, 2023
Energy and Commerce Committee	House	Referred to	Jul 14, 2023
Natural Resources Committee	House	Referred To	Jul 11, 2023
Science, Space, and Technology Committee	House	Referred To	Jul 11, 2023

Subjects & Policy Tags

Policy Area:

Environmental Protection

Related Bills

Bill	Relationship	Last Action
118 S 2228	Identical bill	Oct 2, 2024: Became Public Law No: 118-105.

Summary (as of Jul 11, 2023)

Building Chips in America Act of 2023

This bill modifies and limits the review of certain semiconductor (i.e., microchip) projects under the National Environmental Policy Act of 1969 (NEPA) and the National Historic Preservation Act (NHPA).

Specifically, the bill exempts from NEPA and NHPA specified semiconductor projects that receive financial assistance under the William M. (Mac) Thornberry National Defense Authorization Act for Fiscal Year 2021.

Next, the bill allows the Department of Commerce to serve as the lead agency for the review of a semiconductor project that receives such financial assistance but is not exempted from review under NEPA. A single environmental document and joint record of decision must be prepared for a semiconductor project. In completing the environmental review, Commerce may adopt a prior study or decision under certain circumstances. The bill also allows a state to assume the responsibility of an environmental review under NEPA for a semiconductor project.

Finally, the bill sets a statute of limitations for certain claims under NEPA.

Actions Timeline

- **Jul 14, 2023:** Referred to the Subcommittee on Innovation, Data, and Commerce.
- **Jul 11, 2023:** Introduced in House
- **Jul 11, 2023:** Referred to the Committee on Science, Space, and Technology, and in addition to the Committees on Energy and Commerce, Armed Services, and Natural Resources, for a period to be subsequently determined by the Speaker, in each case for consideration of such provisions as fall within the jurisdiction of the committee concerned.